



General Description

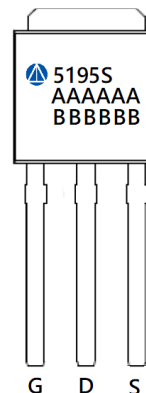
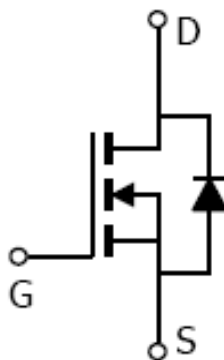
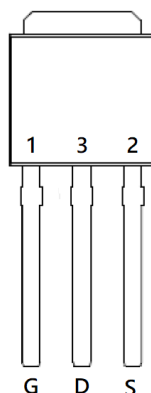
AFN5195S, N-Channel enhancement mode MOSFET, uses Advanced Trench Technology to provide excellent $R_{DS(ON)}$, low gate charge.

These devices are particularly suited for low voltage power management, and low in-line power loss are needed in commercial industrial surface mount applications.

Features

- 100V/20A, $R_{DS(ON)}=11m\Omega@V_{GS}=10V$
- 100V/15A, $R_{DS(ON)}=13m\Omega@V_{GS}=4.5V$
- Super high density cell design for extremely low $R_{DS(ON)}$
- TO-251-3L package design

Pin Description (TO-251-3L)



Application

- Primary Side Switch
- POL Synchronous buck converter
- LED Backlight for LCD TV

Pin Define

Pin	Symbol	Description
1	G	Gate
2	S	Source
3	D	Drain

Ordering Information

Part Ordering No.	Part Marking	Package	Unit	Quantity
AFN5195ST251TG	5195S	TO-251-3L	Tube	80 EA

- ※ A Lot code
- ※ B Date code
- ※ AFN5195ST251TG : Tube ; Pb- Free ; Halogen –Free



※ **Absolute Maximum Ratings**

※ (T_A=25°C Unless otherwise noted)

Parameter	Symbol	Typical	Unit
Drain-Source Voltage	V _{DSS}	100	V
Gate-Source Voltage	V _{GSS}	±20	V
Continuous Drain Current(T _J =150°C)	I _D	T _C =25°C	50
		T _C =70°C	30
		T _A =25°C	15
		T _A =70°C	12
Pulsed Drain Current	I _{DM}	120	A
Continuous Source Current(Diode Conduction)	I _S	16	
Single Pulse Avalanche Current	I _{AS}	25	
Power Dissipation	P _D	T _C =25°C	
		T _C =70°C	30
Operating Junction Temperature	T _J	150	°C
Storage Temperature Range	T _{STG}	-55/150	°C
Thermal Resistance-Junction to Ambient	R _{θJA}	62.5	°C/W

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※ **Electrical Characteristics** (T_A=25°C Unless otherwise noted)

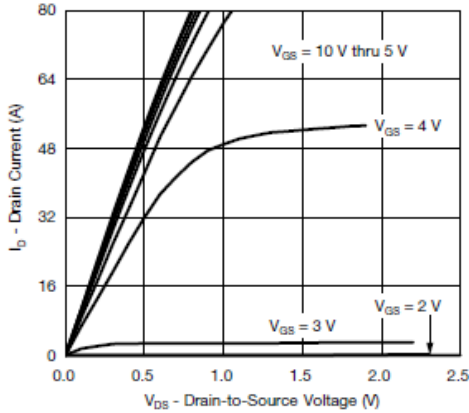
Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0V, I _D =250uA	100			V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250uA	1.0		2.5	
Gate Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} =±20V			±100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =100V, V _{GS} =0V			1	uA
		V _{DS} =100, V _{GS} =0V T _J =85°C			30	
On-State Drain Current	I _{D(on)}	V _{DS} ≥ 5V, V _{GS} =10V	30			A
Drain-Source On-Resistance	R _{DS(on)}	V _{GS} =10V, I _D =20A		8	11	mΩ
		V _{GS} =4.5V, I _D =15A		10	13	
Forward Transconductance	g _{FS}	V _{DS} =10, I _D =20A		54		S
Diode Forward Voltage	V _{SD}	I _S =5A, V _{GS} =0V		0.75	1.2	V
Dynamic						
Total Gate Charge	Q _g	V _{DS} =50V, V _{GS} =4.5V I _D ≒10A		16	25	nC
Gate-Source Charge	Q _{gs}			5		
Gate-Drain Charge	Q _{gd}			7.5		
Gate Resistance	R _g	f=1MHz	0.2	0.8	1.6	Ω
Input Capacitance	C _{iss}	V _{DS} =50V, V _{GS} =0V f=1MHz		1650		pF
Output Capacitance	C _{oss}			720		
Reverse Transfer Capacitance	C _{rss}			50		
Turn-On Time	t _{d(on)}	V _{DD} =50V, R _L =5Ω I _D ≒10A, V _{GEN} =10V R _G =1Ω		12	24	ns
	t _r			8	16	
Turn-Off Time	t _{d(off)}			28	55	
	t _f			8	16	

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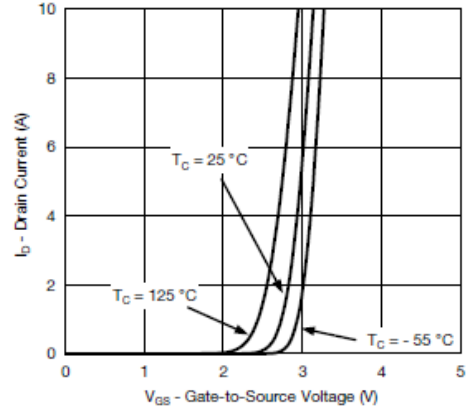


※ Typical Characteristics

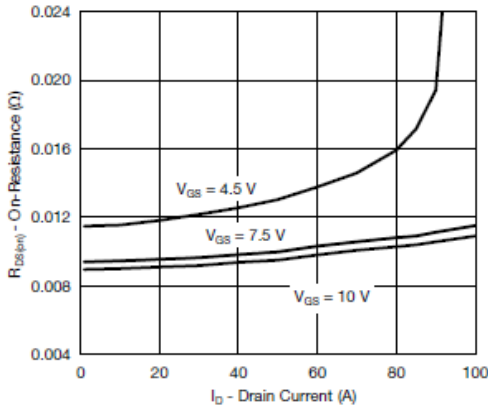
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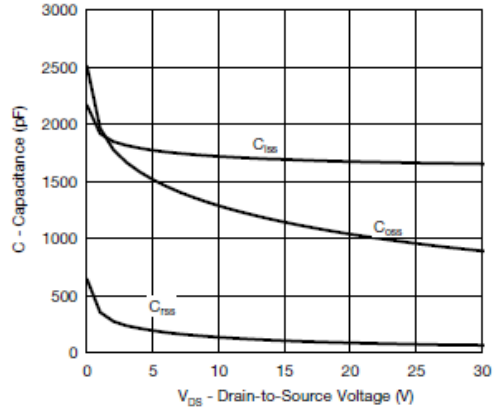
Output Characteristics



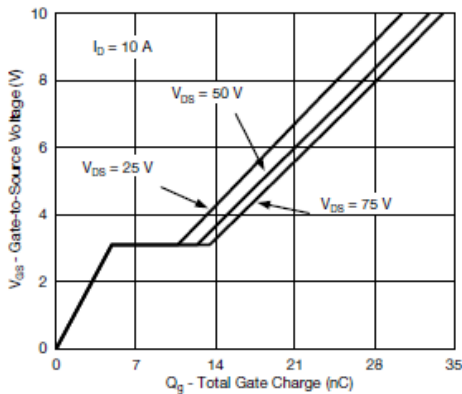
Transfer Characteristics



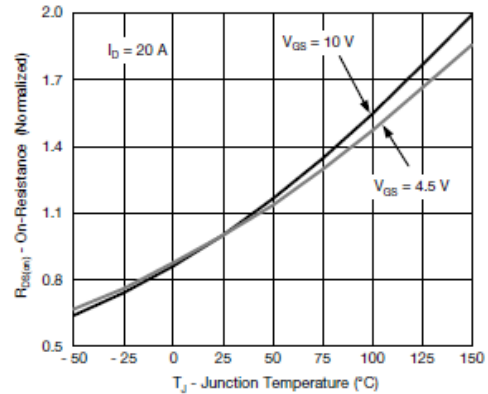
On-Resistance vs. Drain Current and Gate Voltage



Capacitance



Gate Charge



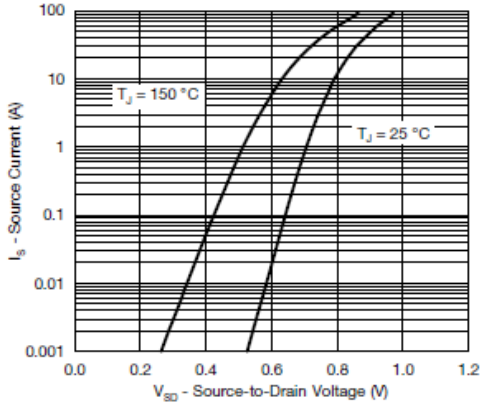
On-Resistance vs. Junction Temperature

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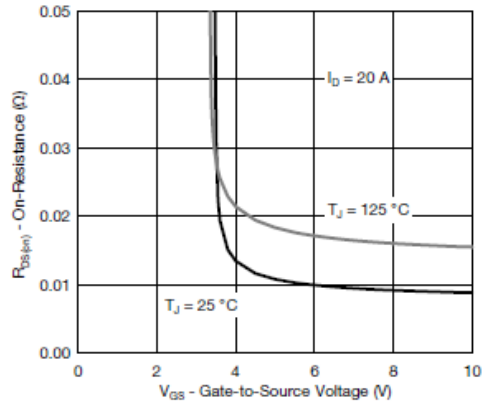


※ Typical Characteristics

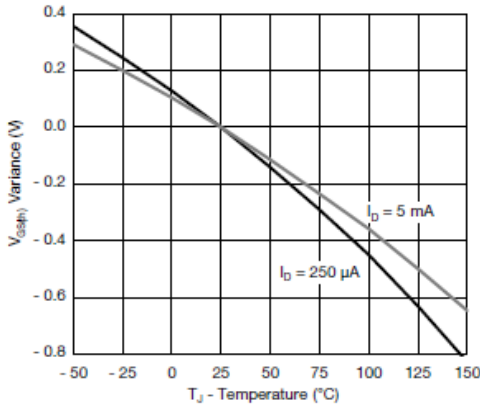
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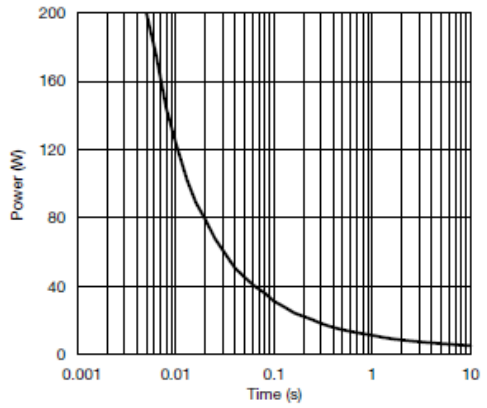
Source-Drain Diode Forward Voltage



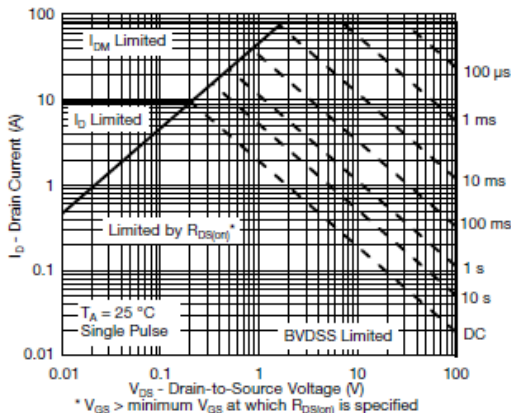
On-Resistance vs. Gate-to-Source Voltage



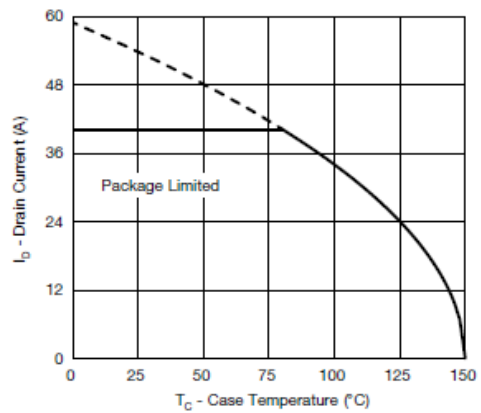
Threshold Voltage



Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient

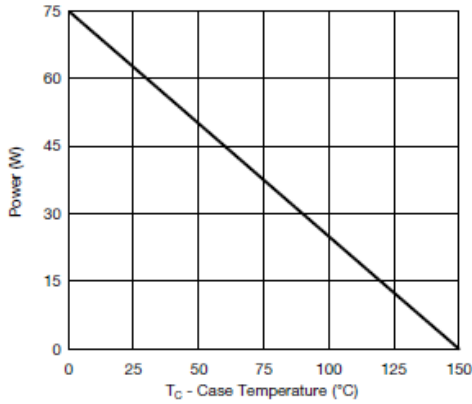


Current Derating^a

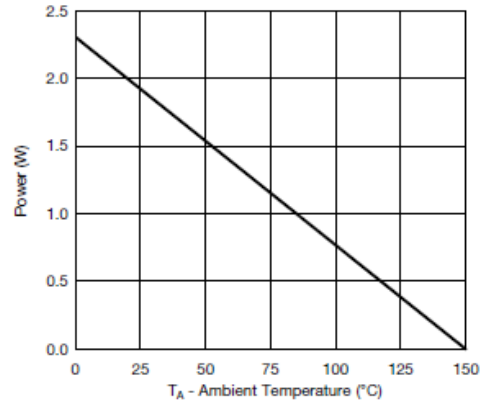


※ Typical Characteristics

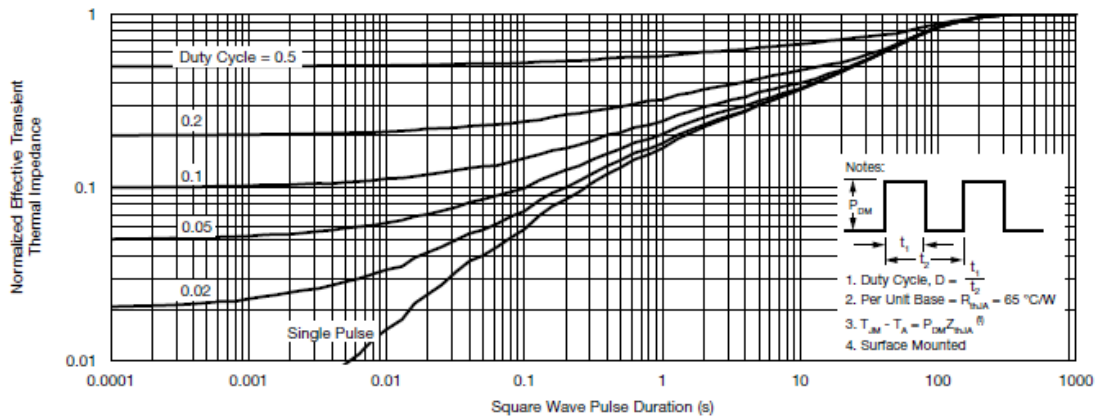
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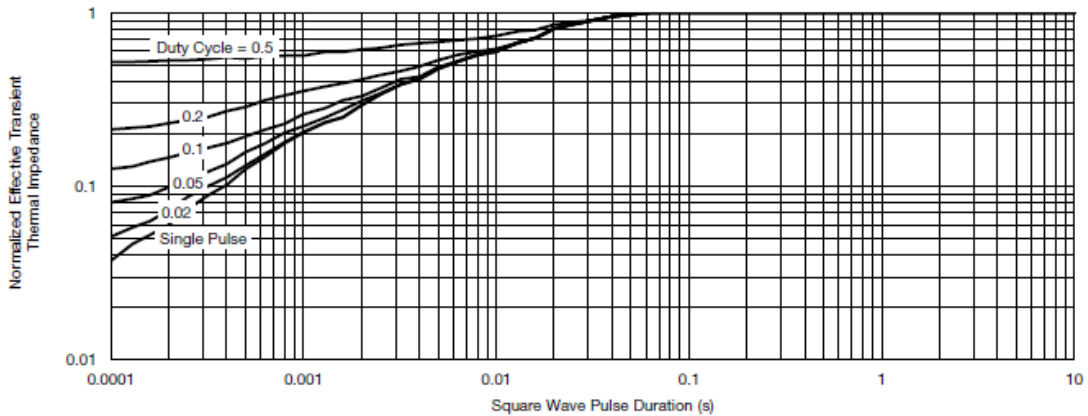
Power, Junction-to-Case



Power, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Ambient



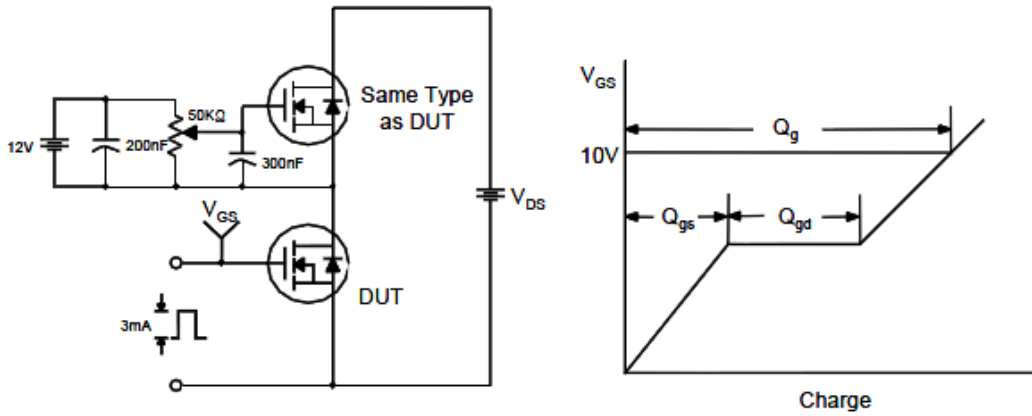
Normalized Thermal Transient Impedance, Junction-to-Case

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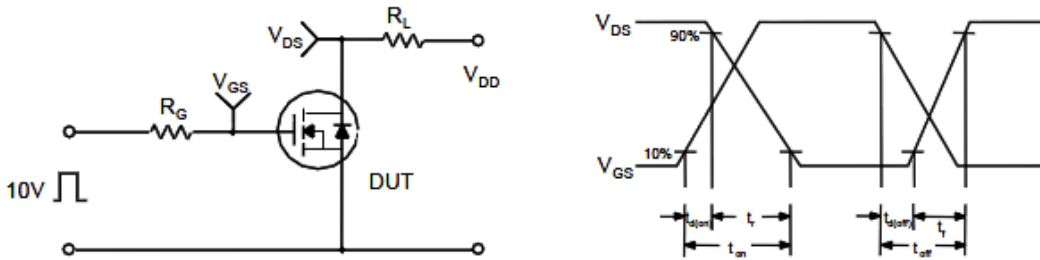


Typical Characteristics

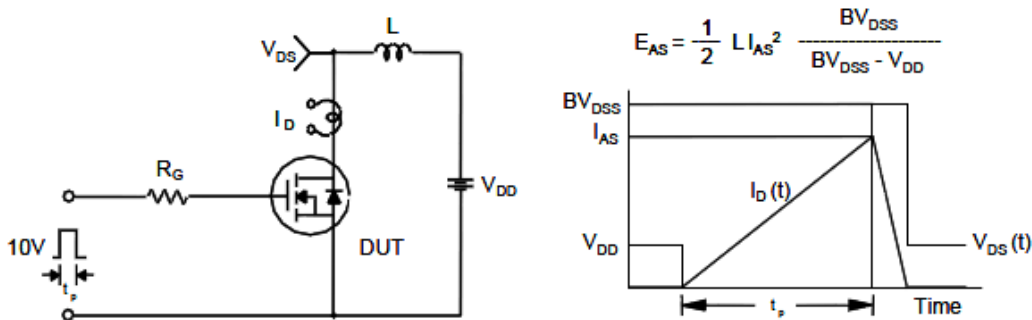
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveforms

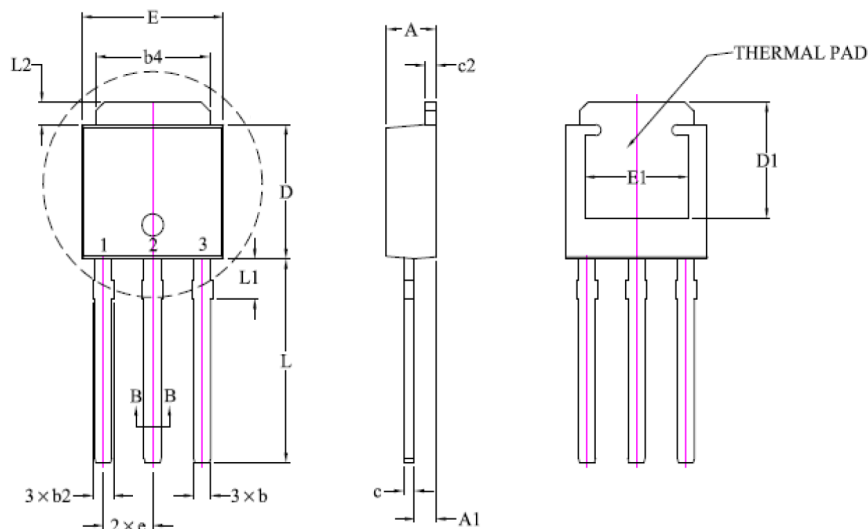


Unclamped Inductive Switching Test Circuit & Waveforms





Package Information (TO-251-3L)



Symbol	Millimeters		Inches	
	Min	Max	Min	Max
A	2.220	2.420	0.087	0.095
A1	0.890	1.140	0.035	0.045
b	0.550	0.670	0.022	0.026
b1	0.550	0.650	0.022	0.025
b2	0.760	0.960	0.030	0.038
b4	5.200	5.400	0.205	0.213
c	0.460	0.570	0.018	0.023
c1	0.450	0.550	0.018	0.022
c2	0.450	0.550	0.018	0.022
D	5.950	6.250	0.234	0.246
D1	4.200	4.500	0.165	0.177
E	6.400	6.700	0.252	0.264
E1	4.750	4.850	0.187	0.191
e	2.28 REF		0.090 REF	
L	8.900	9.500	0.350	0.374
L1	1.900	2.290	0.075	0.090
L2	0.900	1.000	0.035	0.039

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